

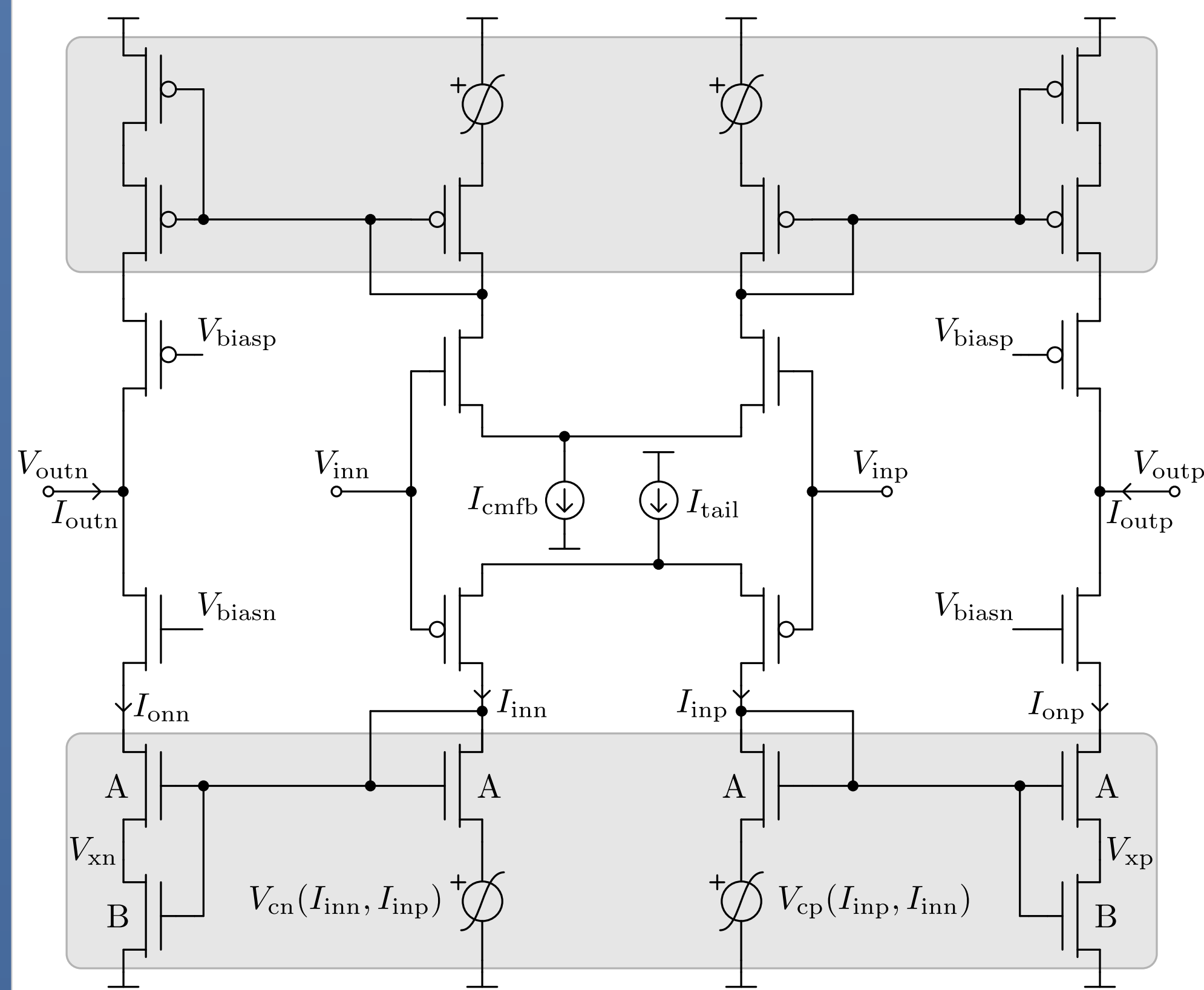
Class-AB Single-Stage OpAmp for Low-Power Switched-Capacitor Circuits

Abstract

A new family of Class-AB OpAmp circuits based on single-stage topologies with non-linear current amplifiers is presented. The proposed architecture is characterized by generating all Class-AB current in the output transistors only. It exhibits low sensitivity to technology parameter variations and avoids the need for internal frequency compensation. It is suitable for low-power switched-capacitor circuits and optimized for a fast on-off operation and multi-decade load-capacitance specifications. A complete OpAmp design example is integrated in a standard 0.18- μm 1P6M CMOS technology. Compared to the MOS-only state-of-the-art Class-AB OpAmps, the presented architecture obtains the highest figure of merit.

Architecture

A single-stage-OpAmp architecture is proposed with two complementary Class-AB control paths for the NMOS and PMOS output transistors.



Supposing strong inversion operation for all boxed devices, each non-linear current amplifier behaves as

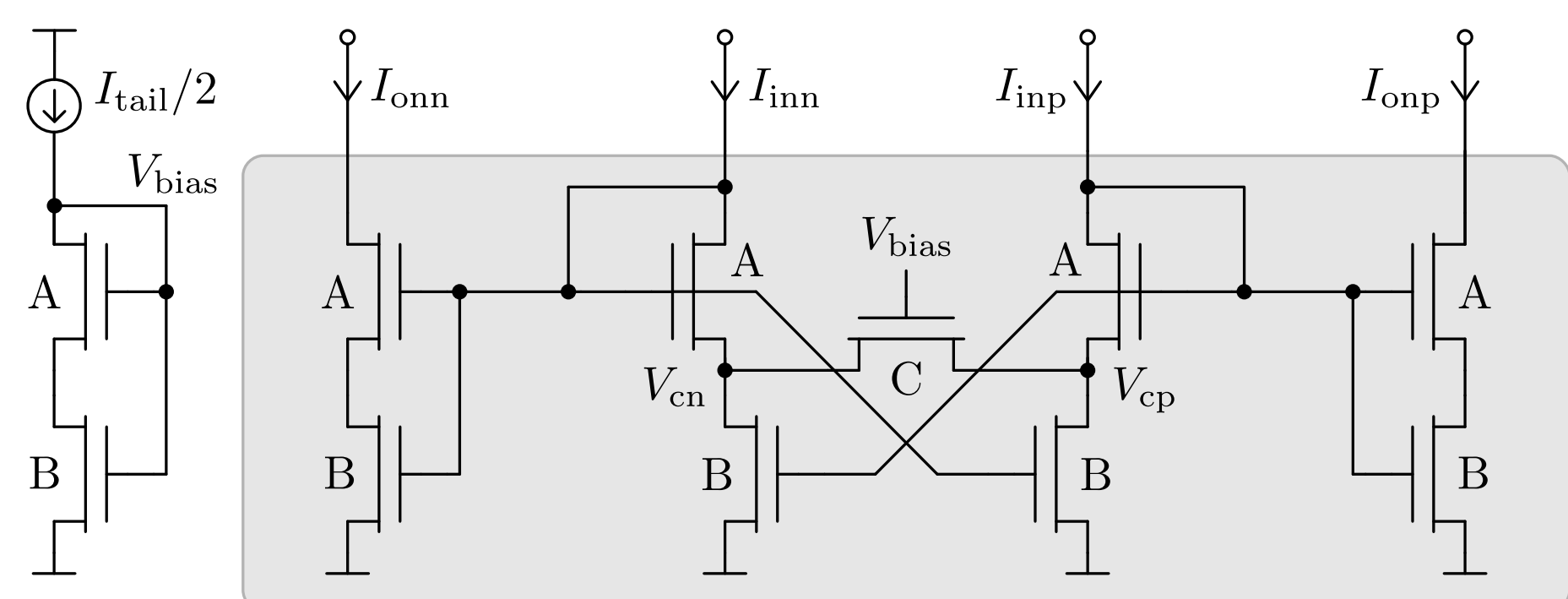
$$\sqrt{\frac{I_{\text{onp}}}{D}} = \sqrt{\frac{I_{\text{inp}}}{A}} + \sqrt{\frac{n\beta}{2} V_{\text{cp}}} \quad D \doteq \frac{AB}{A+B}$$

From the Class-AB viewpoint, the wanted functionality for these voltage-controlled current mirrors is:

$$\begin{cases} I_{\text{outp}} \equiv 0 & V_{\text{cp}} \equiv V_{\text{xp}} & I_{\text{onp}} \equiv I_{\text{inp}} \equiv \frac{I_{\text{tail}}}{2} & \text{Bias point} \\ I_{\text{outp}} \neq 0 & V_{\text{cp}} \neq V_{\text{xp}} & \begin{cases} I_{\text{onp}} \ll I_{\text{inp}} \\ I_{\text{onp}} \gg I_{\text{inp}} \end{cases} & \text{Class-AB operation} \end{cases}$$

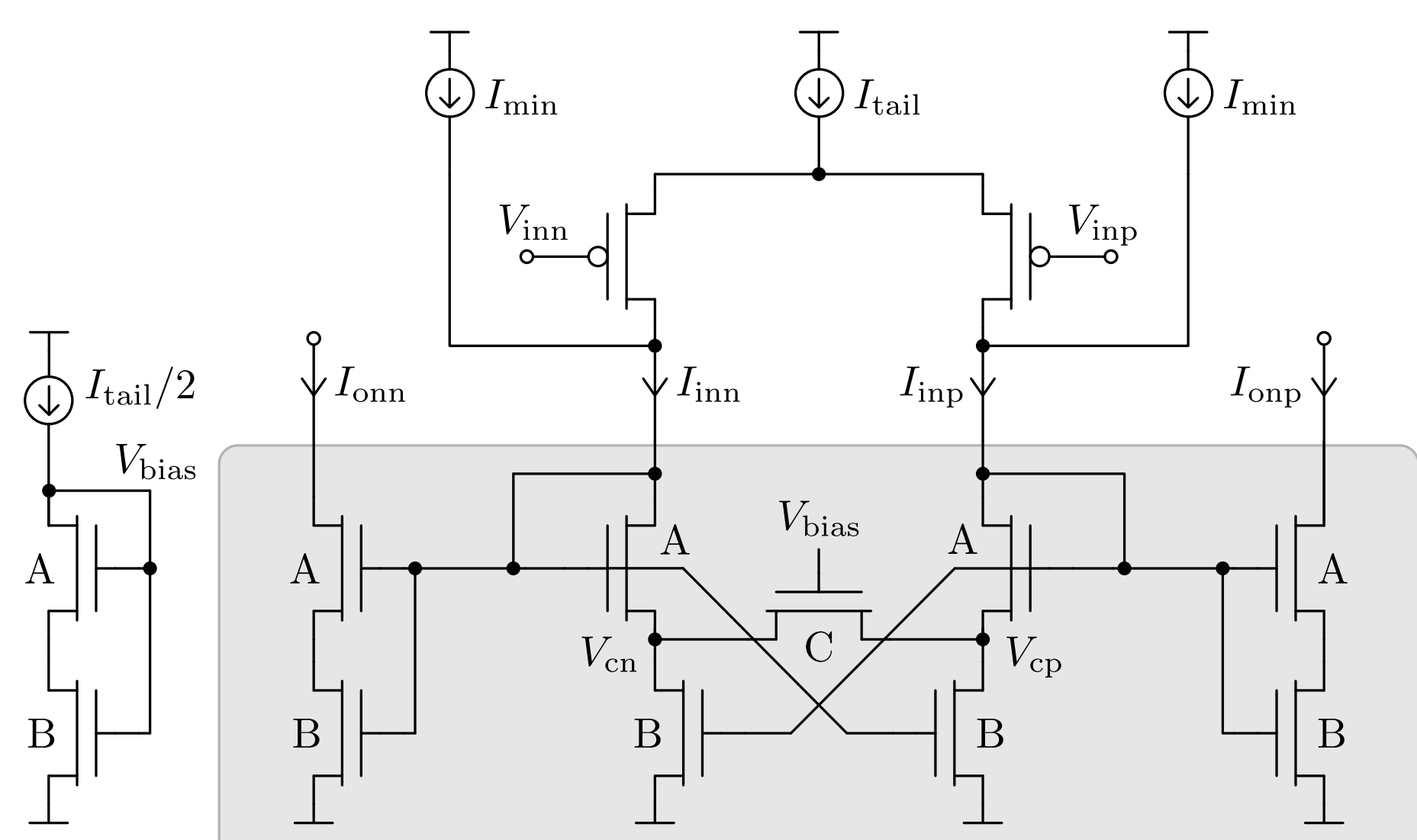
Type-I Circuit

A cross-coupled pair (B-B) is introduced to provide the positive feedback for the Class-AB operation, while a crossing transistor (C) play the role of a feedback limiter.



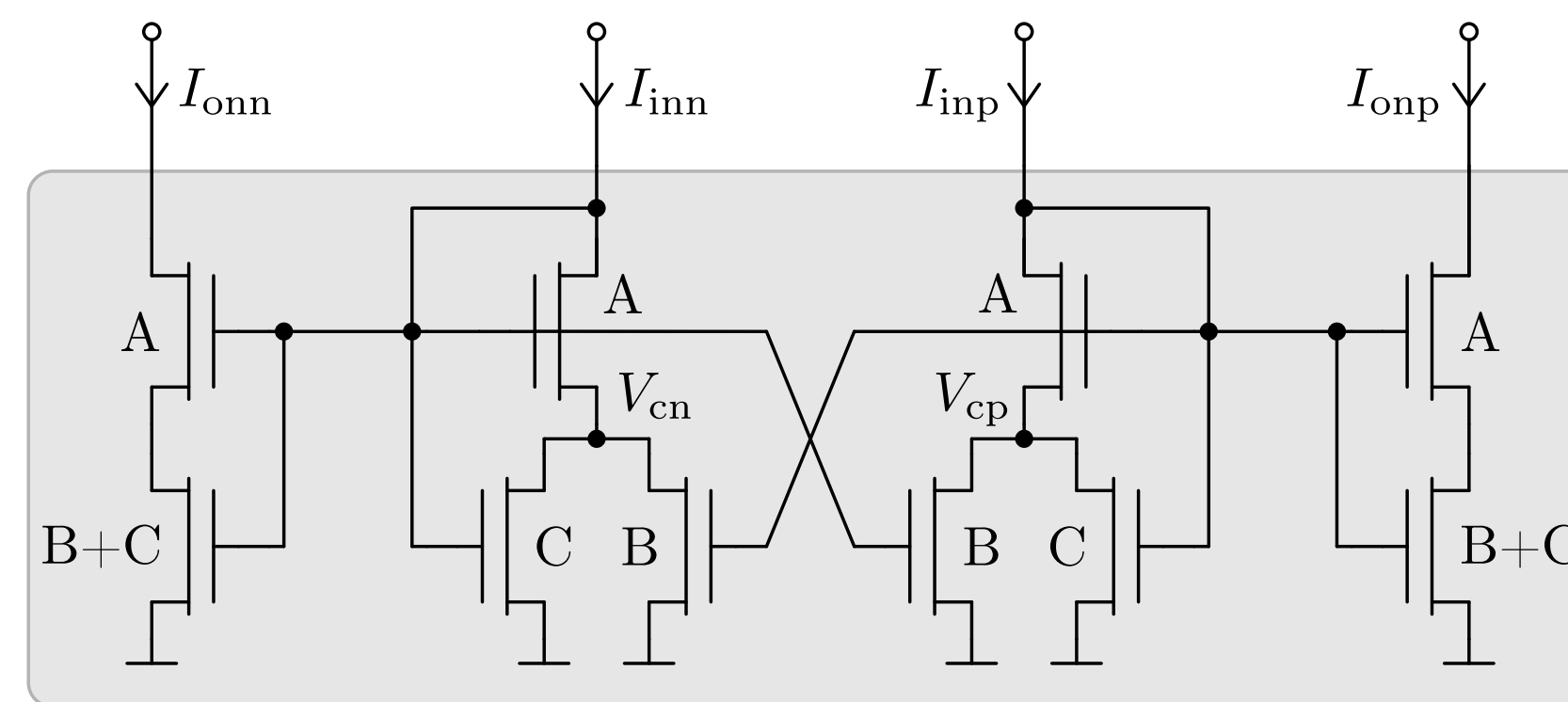
$$I_{\text{inp}} = B \left(2\sqrt{\frac{I_{\text{onn}}}{D}} - \sqrt{\frac{I_{\text{onp}}}{D}} + \sqrt{\frac{I_{\text{inp}}}{A}} \right) \left(\sqrt{\frac{I_{\text{onp}}}{D}} - \sqrt{\frac{I_{\text{inp}}}{A}} \right) + C \left(\sqrt{\frac{2I_{\text{tail}}}{D}} - \sqrt{\frac{I_{\text{onp}}}{D}} - \sqrt{\frac{I_{\text{inp}}}{A}} + \sqrt{\frac{I_{\text{inp}}}{A}} \right) \left(\sqrt{\frac{I_{\text{onp}}}{D}} - \sqrt{\frac{I_{\text{onp}}}{D}} - \sqrt{\frac{I_{\text{inp}}}{A}} + \sqrt{\frac{I_{\text{inp}}}{A}} \right)$$

The process parameters β and n disappear from the current-amplifier equation. Hence, independence from technology is achieved. Under Class-AB high modulation, common-mode currents can be injected to prevent a possible self-latch.



Type-II Circuit

Here, the crossing transistor (C) of the Type-I circuit is replaced by two split counterparts (C-C), which are auto-biased. Thus, extra reference circuits are not needed and power consumption is reduced.



$$I_{\text{inp}} = \left[2 \left(B \sqrt{\frac{I_{\text{onn}}}{D}} + C \sqrt{\frac{I_{\text{onp}}}{D}} \right) - (B+C) \left(\sqrt{\frac{I_{\text{onp}}}{D}} - \sqrt{\frac{I_{\text{inp}}}{A}} \right) \right] \left(\sqrt{\frac{I_{\text{onp}}}{D}} - \sqrt{\frac{I_{\text{inp}}}{A}} \right)$$

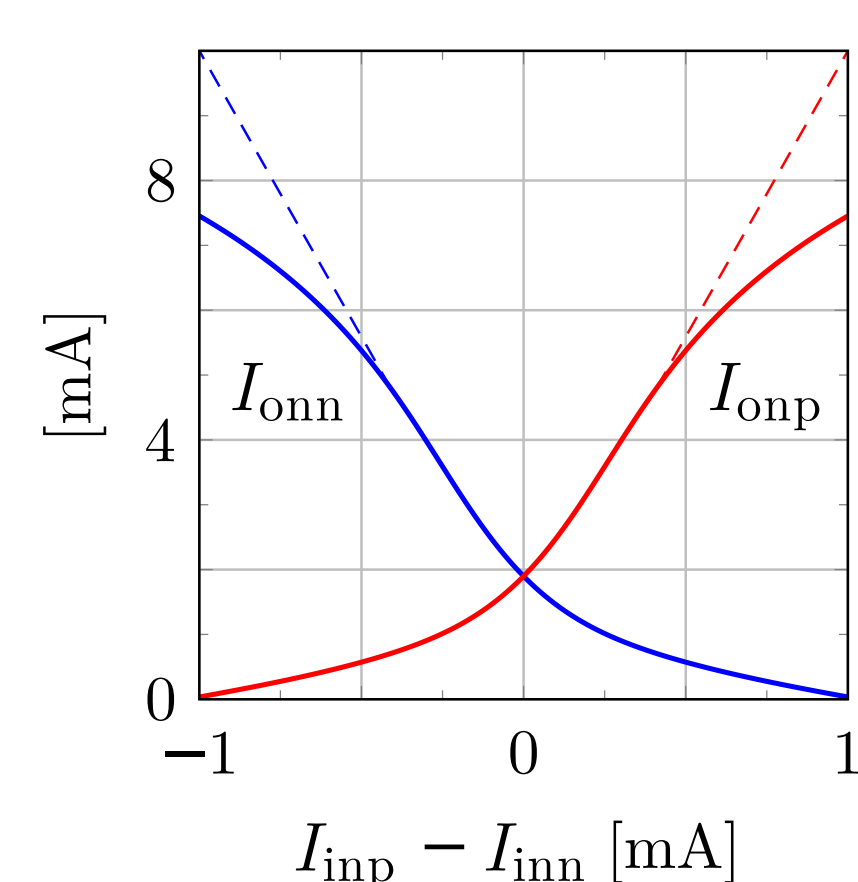
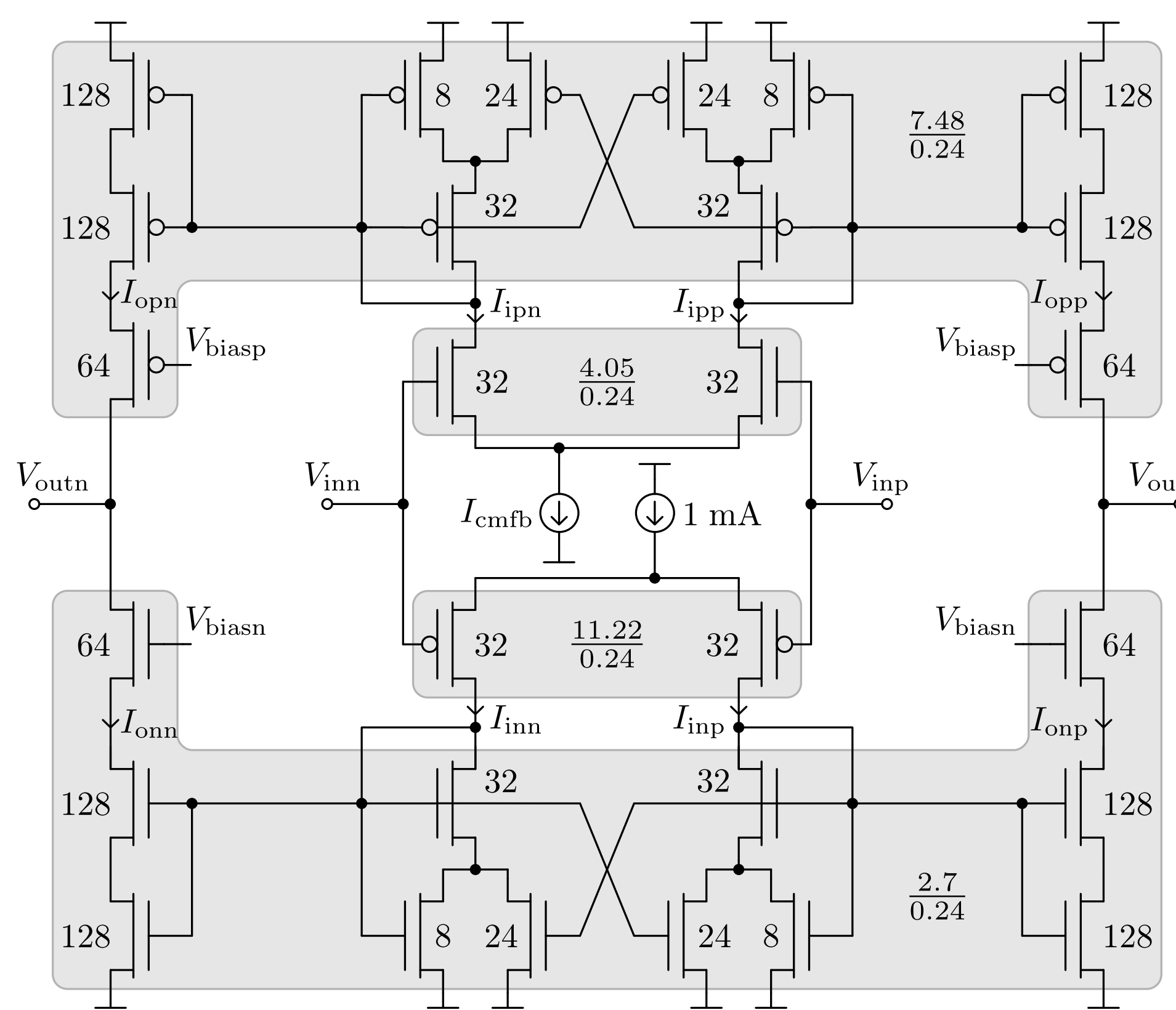
$$D \doteq \frac{A(B+C)}{A+B+C}$$

$$I_{\text{max}} \approx \frac{1+A}{1+B+C} I_{\text{tail}} > I_{\text{tail}}$$

Independence from the technology parameters is also preserved.

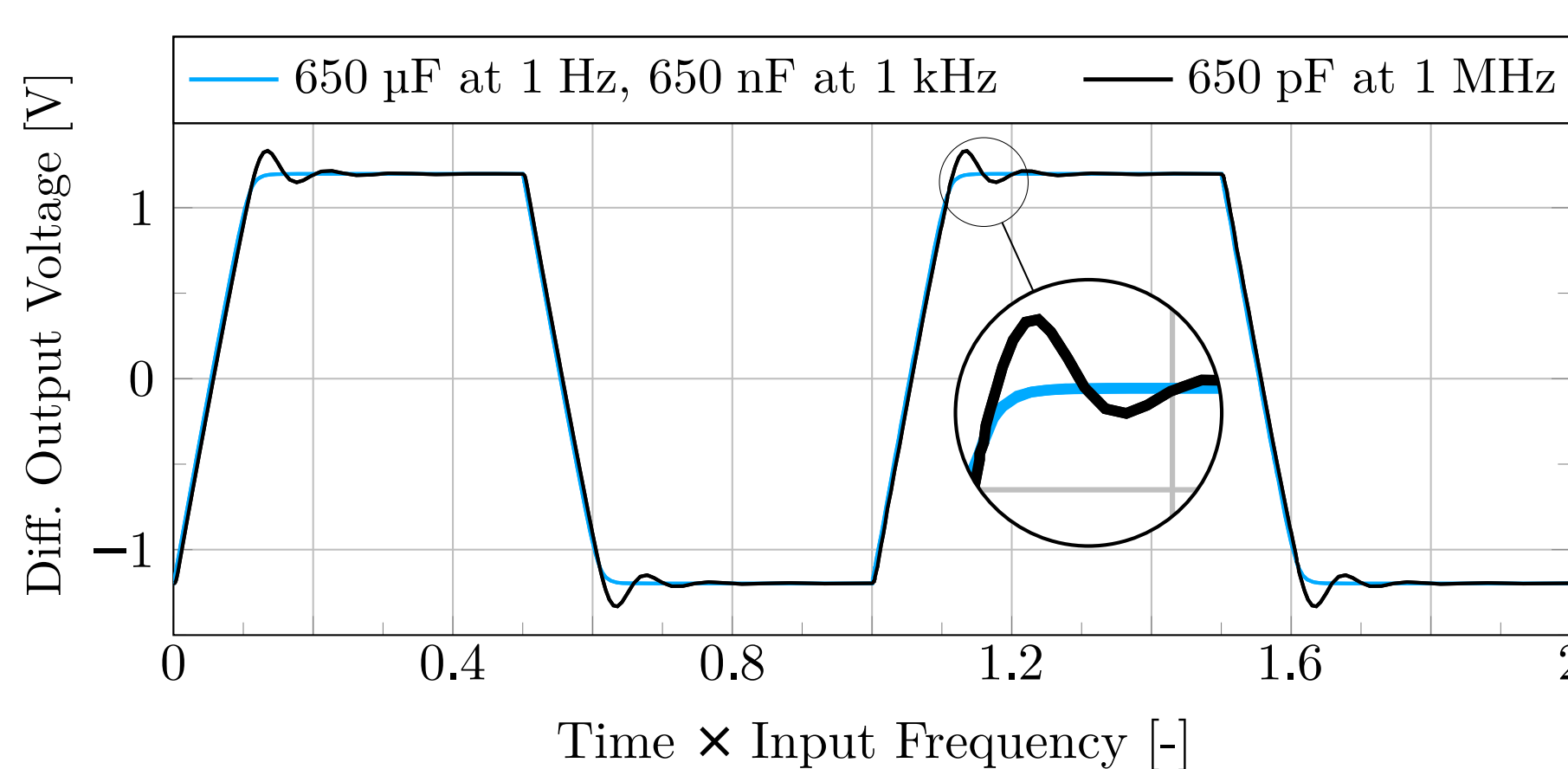
Practical Design

Type-II architecture is chosen for the design example in a 0.18- μm CMOS technology node.

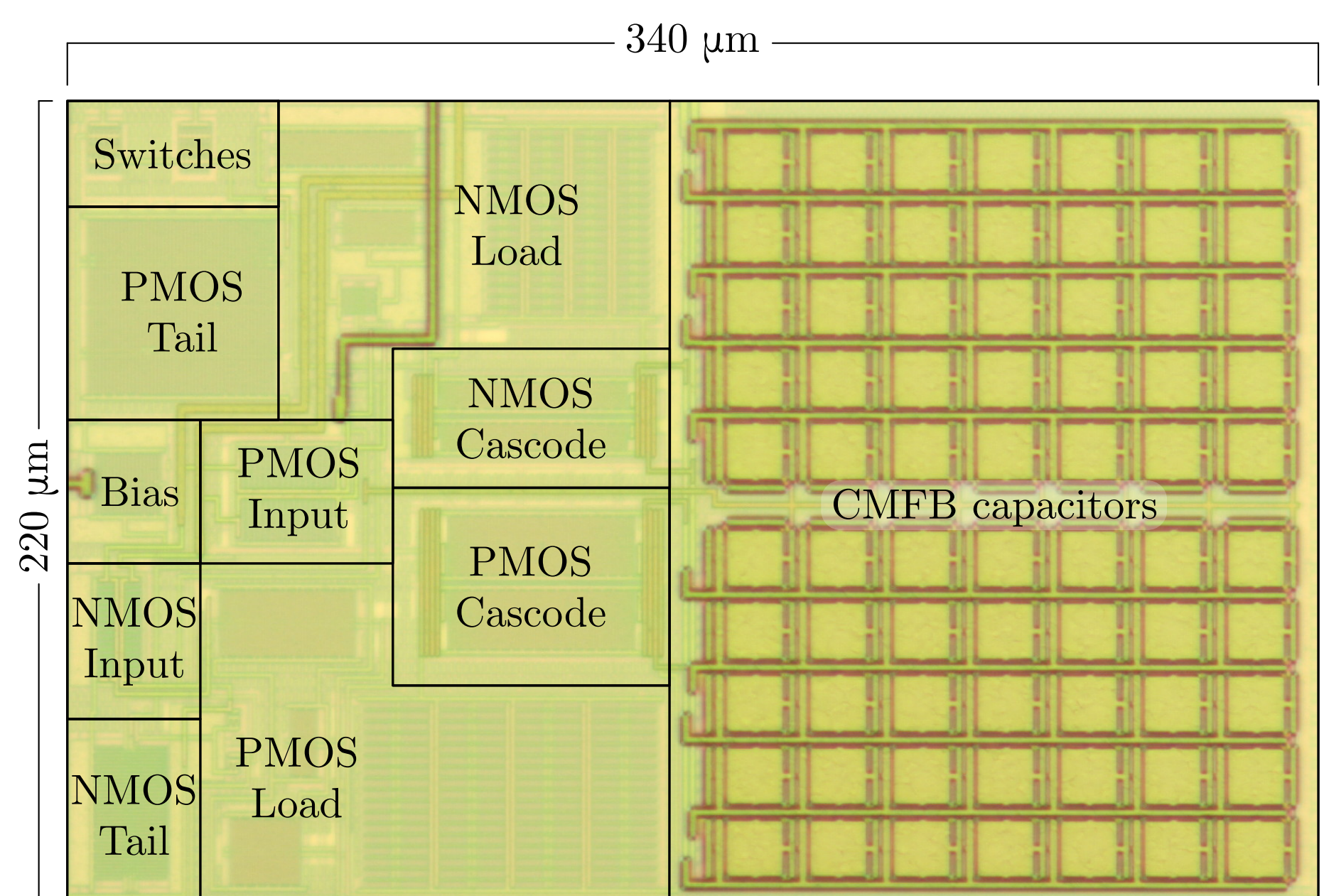


As shown, the number of transistor groups is minimized and minimum device lengths can be used. In this particular case, optimization finds the best performance for $A=4$, $B=3$ and $C=1$. The Class-AB behavior is demonstrated for the NMOS outputs.

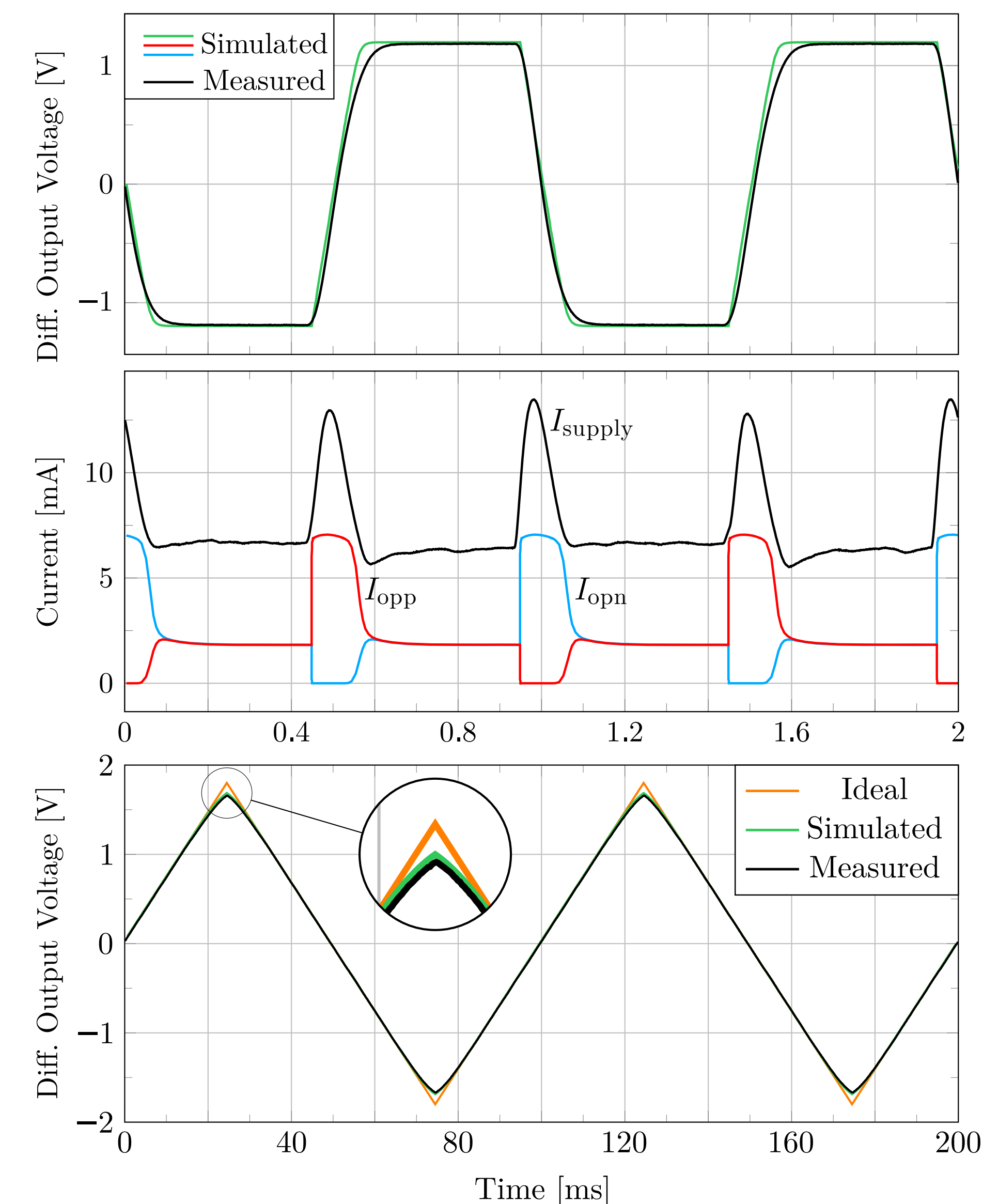
The OpAmp is stable for a wide range of load capacitance values.



The OpAmp is integrated using a standard 0.18- μm 1P6M CMOS technology, achieving an overall area of 0.07- mm^2 . The circuit layout includes additional common-mode feedback (CMFB) averaging capacitors for switched-capacitor applications.



Experimental Results



Operating at a 1.8-V power supply, a remarkable differential full scale of $3.3 V_{\text{pp}}$ is measured. The performance of the proposed OpAmp is compared with others from published Class-AB amplifiers [1]–[5] by using the figure of merit (FOM) from [5]

$$\text{FOM} = \frac{\text{SR} \cdot C_{\text{load}}}{P} \left[\frac{\text{V} \cdot \text{pF}}{\mu\text{s} \cdot \mu\text{W}} \right]$$

Parameter	[1]	[2]	[3]	[4]	[5]	This work	Units
Technology	0.5	0.5	0.25	0.13	0.18	0.18	μm
Supply	2	2	1.2	1.2	0.8	1.8	V
DC gain	43	45	69	70	51	72	dB
C_{load}	80	25	4	5.5	8	200	pF
GBW	0.725	11	165	35	0.057	86.5	MHz
Phase margin	89.5	N/A	65	45	60	50	$^{\circ}$
Slew rate, SR	89	20	329	19.5	0.14	74.1	V/ μs
Static power, P	0.12	0.04	5.8	0.11	0.0012	11.9	mW
Area	0.024	0.012	N/A	0.012	0.057	0.07	mm^2
FOM	59.33	12.50	0.28	0.98	0.93	1.25	$\frac{\text{V} \cdot \text{pF}}{\mu\text{s} \cdot \mu\text{W}}$

The works [1], [2] report higher FOM, but at the cost of requiring integrated resistors, which makes them more sensitive to technology parameter variations, and of a considerable lowering of their DC gain, which may be incompatible with high-precision applications. The works using MOS-only devices [3]–[5] present lower FOM and DC gain. Therefore, a contribution to the improvement of MOS-only Class-AB OpAmps is demonstrated.

Conclusions

- A new family of Class-AB OpAmps has been presented.
- The architecture is based on a **single-stage** topology.
- The circuits do **not need** any internal frequency **compensation**.
- The Class-AB current peaks are produced in the output transistors only.
- The resulting OpAmps exhibit **low sensitivity** to the technology parameter variations.
- Good performance is achieved using a **simple design flow**.
- The Type II has been **successfully used** in a 16-bit 100-kS/s $\Delta\Sigma$ ADC.

References

- [1] A. J. Lopez-Martín, S. Baswa, J. Ramirez-Angulo, and R. G. Carvajal, "Low-Voltage Super Class AB CMOS OTA Cells With Very High Slew Rate and Power Efficiency," *IEEE Journal of Solid-State Circuits*, vol. 40, pp. 1068–1077, 2005.
- [2] J. Ramirez-Angulo, R. G. Carvajal, J. A. Galan, and A. Lopez-Martín, "A Free But Efficient Low-Voltage Class-AB Two-Stage Operational Amplifier," *IEEE Transactions on Circuits and Systems II: Expressed Briefs*, vol. 53, pp. 568–571, 2006.
- [3] M. Yavary and O. Shoaie, "Very Low-Voltage, Low-Power and Fast-Settling OTA for Switched-Capacitor Applications," in *Proceedings of the International Conference on Microelectronics*, 2002, pp. 10–13.
- [4] M. Figueiredo, R. Santos-Tavares, E. Santin, J. Ferreira, G. Evans, and J. Goes, "A Two-Stage Fully Differential Inverter-Based Self-Biased CMOS Amplifier With High Efficiency," *IEEE Transactions on Circuits and Systems I: Regular Papers*, vol. 58, pp. 1591–1603, 2011.
- [5] M. R. Valero, S. Celma, N. Medrano, B. Calvo, and C. Azcona, "An Ultra Low-Power Low-Voltage Class AB CMOS Fully Differential OpAmp," in *Proceedings of the IEEE International Symposium on Circuits and Systems*, 2012, pp. 1967–1970.